Record Nr. UNINA9910822567603321 Autore Caniggia Spartaco Titolo Signal integrity and radiated emission of high-speed digital systems // Spartaco Caniggia, Francescaromana Maradei Chichester, U.K., : Wiley, 2008 Pubbl/distr/stampa **ISBN** 9786612010712 9781282010710 1282010719 9780470772874 0470772875 9780470772881 0470772883 Edizione [1st edition] Descrizione fisica 1 online resource (554 p.) Classificazione 05.42 Altri autori (Persone) MaradeiFrancescaromana Disciplina 621.382/24 Soggetti Electromagnetic interference Digital electronics Very high speed integrated circuits Crosstalk Signal processing Lingua di pubblicazione Inglese **Formato** Materiale a stampa Livello bibliografico Monografia Note generali Description based upon print version of record. Nota di bibliografia Includes bibliographical references and index. Nota di contenuto SIGNAL INTEGRITY ANDRADIATED EMISSIONOF HIGH-SPEED DIGITAL SYSTEMS; Contents; List of Examples; Foreword; Preface; 1 Introduction to Signal Integrity and Radiated Emission in a Digital System; 1.1 Power and Signal Integrity; 1.1.1 Power Distribution Network; 1.1.2 Signal Distribution Network; 1.1.3 Noise Limitations and Design for Characteristic Impedance; 1.2 Radiated Emission; 1.2.1 Definition of Radiated Emission Sources; 1.2.2 Radiated Emission Standards; 1.2.3 Radiated Emission from a Real System; 1.3 Signaling and Logic Devices; 1.3.1 Overshoot, Undershoot and Plateau 1.3.2 Noise Immunity1.3.3 Timing Parameters; 1.3.4 Eye Diagram; 1.4

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Sommario/riassunto

Before putting digital systems for information technology or telecommunication applications on the market, an essential requirement is to perform tests in order to comply with the limits of radiated emission imposed by the standards. This book provides an investigation into signal integrity (SI) and electromagnetic interference (EMI) problems. Topics such as reflections, crosstalk, switching noise and radiated emission (RE) in high-speed digital systems are covered, which are essential for IT and telecoms applications. The highly important topic of modelling is covered which can reduce costs